

**SN54S64, SN54S65,
SN74S64, SN74S65**
4-2-3-2 INPUT AND-OR-INVERT GATES
SDLS205 – DECEMBER 1983 – REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs

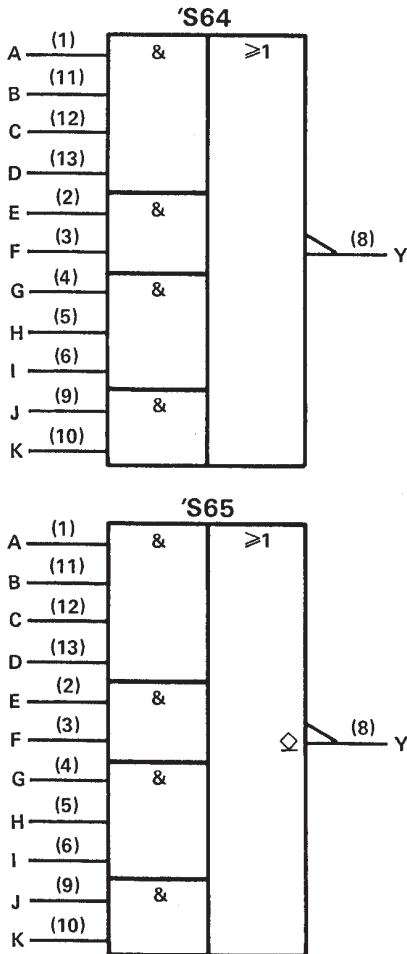
- Dependable Texas Instruments Quality and Reliability

description

These devices contain 4-2-3-2 input AND-OR-INVERT gates. They perform the Boolean function $Y = \overline{ABCD + EF + GHI + JK}$. The 'S64 has totem-pole outputs and the 'S65 has open-collector outputs.

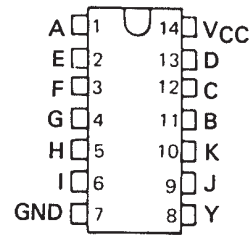
The SN54S64 and the SN54S65 are characterized for operation over the full military temperature range of -55°C to 125°C . The SN74S64 and the SN74S65 are characterized for operation from 0°C to 70°C .

logic symbols†

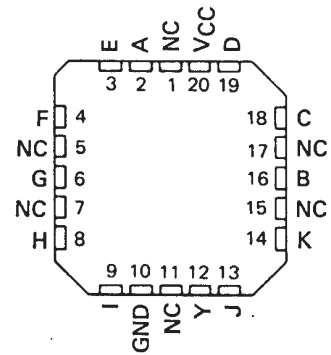


†These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.

SN54S64, SN54S65 . . . J OR W PACKAGE
SN74S64, SN74S65 . . . D OR N PACKAGE
(TOP VIEW)

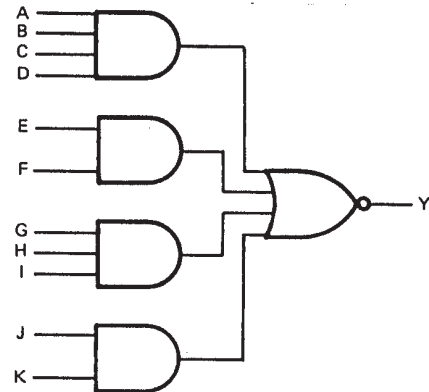


SN54S64, SN54S65 . . . FK PACKAGE
(TOP VIEW)



NC - No internal connection

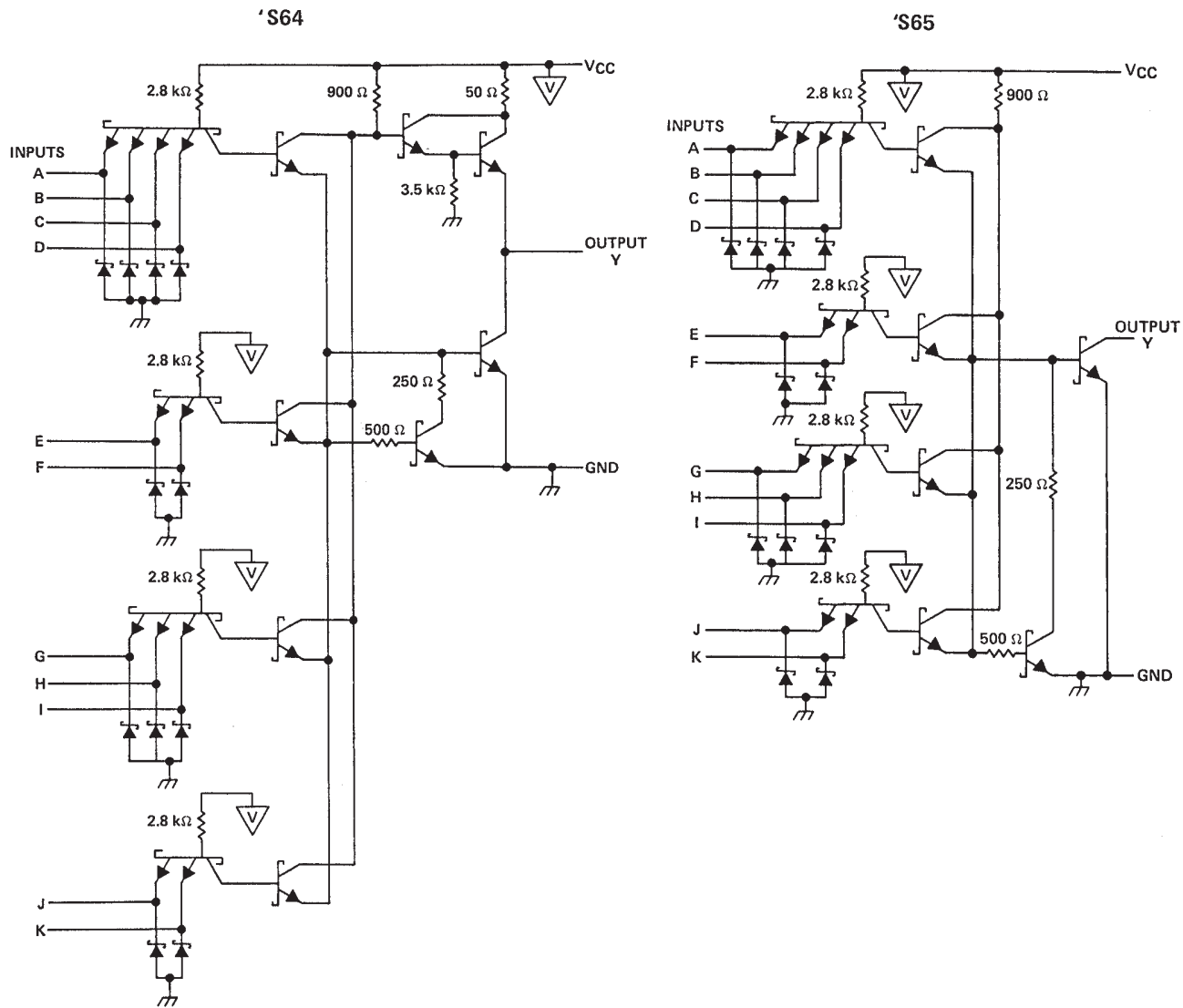
logic diagram (each device) (positive logic)



**SN54S64, SN54S65,
SN74S64, SN74S65**
4-2-3-2 INPUT AND-OR-INVERT GATES

SDLS205 – DECEMBER 1983 – REVISED MARCH 1988

schematics (each gate)



Resistor values shown are nominal and in ohms.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage	5.5 V
Off-state output voltage, 'S65	7 V
Operating free-air temperature range: SN54'	-55°C to 125°C
SN74'	0°C to 70°C
Storage temperature range	-65°C to 150°C



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SN54S64, SN54S65

4-2-3-2 INPUT AND-OR-INVERT GATES

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recommended operating conditions

	SN54S64			SN74S64			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH} High-level input voltage	2			2			V
V_{IL} Low-level input voltage			0.8			0.8	V
I_{OH} High-level output current			-1			-1	mA
I_{OL} Low-level output current			20			20	mA
T_A Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †	SN54S64		SN74S64		UNIT		
		MIN	TYP ‡	MAX	MIN		TYP ‡	MAX
V_{IK}	$V_{CC} = \text{MIN}, I_I = -18 \text{ mA}$			-1.2		-1.2	V	
V_{OH}	$V_{CC} = \text{MIN}, V_{IL} = 0.8 \text{ V}, I_{OH} = -1 \text{ mA}$	2.5	3.4		2.7	3.4	V	
V_{OL}	$V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V}, I_{OL} = 20 \text{ mA}$			0.5		0.5	V	
I_I	$V_{CC} = \text{MAX}, V_I = 5.5 \text{ V}$			1		1	mA	
I_{IH}	$V_{CC} = \text{MAX}, V_I = 2.7 \text{ V}$			50		50	μA	
I_{IL}	$V_{CC} = \text{MAX}, V_I = 0.5 \text{ V}$			-2		-2	mA	
$I_{OS} §$	$V_{CC} = \text{MAX}$	-40		-100	-40	-100	mA	
I_{CCH}	$V_{CC} = \text{MAX}, V_I = 0$		7	12.5		7	12.5	mA
I_{CCL}	$V_{CC} = \text{MAX}, V_I = 4.5 \text{ V}$		8.5	16		8.5	16	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at $V_{CC} = 5 \text{ V}, T_A = 25^\circ \text{C}$.

§ Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

switching characteristics, $V_{CC} = 5 \text{ V}, T_A = 25^\circ \text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
t_{PLH}	Any	Y	$R_L = 280 \Omega, C_L = 15 \text{ pF}$		3.5	5.5	ns	
t_{PHL}					3.5	5.5	ns	
t_{PLH}			$R_L = 280 \Omega, C_L = 50 \text{ pF}$			5		ns
t_{PHL}						5.5		ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

SN54S65, SN54S65

4-2-3-2 INPUT AND-OR-INVERT GATES

SDLS205 – DECEMBER 1983 – REVISED MARCH 1988

recommended operating conditions

	SN54S65			SN74S65			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage	2			2			V
V _{IL} Low-level input voltage			0.8			0.8	V
V _{OH} High-level output voltage			5.5			5.5	V
I _{OL} Low-level output current			20			20	mA
T _A Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†	SN54S65			SN74S65			UNIT
		MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V _{IK}	V _{CC} = MIN, I _I = -18 mA			1.2			1.2	V
I _{OH}	V _{CC} = MIN, V _{IL} = 0.8 V, V _{OH} = 5.5 V						0.25	mA
	V _{CC} = MIN, V _{IL} = 0.7 V, V _{OH} = 5.5 V			0.25				
V _{OL}	V _{CC} = MIN, V _{IH} = 2 V, I _{OL} = 20 mA	0.2	0.4		0.2	0.4		V
I _I	V _{CC} = MAX, V _I = 5.5 V			1			1	mA
I _{IH}	V _{CC} = MAX, V _I = 2.7 V			50			50	μA
I _{IL}	V _{CC} = MAX, V _I = 0.5 V			-2			-2	mA
I _{CCH}	V _{CC} = MAX, V _I = 0	6	11		6	11		mA
I _{CCL}	V _{CC} = MAX, V _I = 4.5 V	8.5	16		8.5	16		mA

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡All typical values are at V_{CC} = 5 V, T_A = 25°C.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _{PLH}	Any	Y	R _L = 280 Ω, C _L = 15 pF	2	5	7.5	ns
t _{PHL}				2	5.5	8.5	ns
t _{PLH}			R _L = 280 Ω, C _L = 50 pF	8		ns	
t _{PHL}				6.5		ns	

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
JM38510/07402BCA	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
JM38510/07402BDA	ACTIVE	CFP	W	14	1	None	Call TI	Level-NC-NC-NC
SN54S64J	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SN74S64D	OBSOLETE	SOIC	D	14		None	Call TI	Call TI
SN74S64DR	OBSOLETE	SOIC	D	14		None	Call TI	Call TI
SN74S64N	OBSOLETE	PDIP	N	14		None	Call TI	Call TI
SN74S64N3	OBSOLETE	PDIP	N	14		None	Call TI	Call TI
SN74S65D	OBSOLETE	SOIC	D	14		None	Call TI	Call TI
SN74S65DR	OBSOLETE	SOIC	D	14		None	Call TI	Call TI
SN74S65N	OBSOLETE	PDIP	N	14		None	Call TI	Call TI
SNJ54S64FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54S64J	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SNJ54S64W	ACTIVE	CFP	W	14	1	None	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - May not be currently available - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265